

Digital Integrated Circuits 2nd Edition

Power Aware Design Methodologies was conceived as an effort to bring all aspects of power-aware design methodologies together in a single document. It covers several layers of the design hierarchy from technology, circuit logic, and architectural levels up to the system layer. It includes discussion of techniques and methodologies for improving the power efficiency of CMOS circuits (digital and analog), systems on chip, microelectronic systems, wirelessly networked systems of computational nodes and so on. In addition to providing an in-depth analysis of the sources of power dissipation in VLSI circuits and systems and the technology and design trends, this book provides a myriad of state-of-the-art approaches to power optimization and control. The different chapters of Power Aware Design Methodologies have been written by leading researchers and experts in their respective areas. Contributions are from both academia and industry. The contributors have reported the various technologies, methodologies, and techniques in such a way that they are understandable and useful.

Low Power Design Methodologies presents the first in-depth coverage of all the layers of the design hierarchy, ranging from the technology, circuit, logic and architectural levels, up to the system layer. The book gives insight into the mechanisms of power dissipation in digital circuits and presents state of the art approaches to power reduction. Finally, it introduces a global view of low power design methodologies and how these are being captured in the latest design automation environments. The individual chapters are written by the leading researchers in the area, drawn from both industry and academia. Extensive references are included at the end of each chapter. Audience: A broad introduction for anyone interested in low power design. Can also be used as a text book for an advanced graduate class. A starting point for any aspiring researcher.

Equips students with essential industry-relevant knowledge through in-depth explanations, practical applications, examples, and exercises.

This book offers comprehensive coverage of a wide, relevant array of operational amplifier topics. KEY TOPICS: The book integrates theory, practical circuits, and troubleshooting concepts, keeping mathematical details to a minimum. Delving more deeply into coverage of operational amplifiers, the book guides readers through a system of pedagogical tools that both reinforces and challenges their understanding. An essential reference in electronic technology.

Polycrystalline Silicon for Integrated Circuits and Displays, Second Edition presents much of the available knowledge about polysilicon. It represents an effort to interrelate the deposition, properties, and applications of polysilicon. By properly understanding the properties of polycrystalline silicon and their relation to the deposition conditions, polysilicon can be designed to ensure optimum device and integrated-circuit performance. Polycrystalline silicon has played an

important role in integrated-circuit technology for two decades. It was first used in self-aligned, silicon-gate, MOS ICs to reduce capacitance and improve circuit speed. In addition to this dominant use, polysilicon is now also included in virtually all modern bipolar ICs, where it improves the basic physics of device operation. The compatibility of polycrystalline silicon with subsequent high-temperature processing allows its efficient integration into advanced IC processes. This compatibility also permits polysilicon to be used early in the fabrication process for trench isolation and dynamic random-access-memory (DRAM) storage capacitors. In addition to its integrated-circuit applications, polysilicon is becoming vital as the active layer in the channel of thin-film transistors in place of amorphous silicon. When polysilicon thin-film transistors are used in advanced active-matrix displays, the peripheral circuitry can be integrated into the same substrate as the pixel transistors. Recently, polysilicon has been used in the emerging field of microelectromechanical systems (MEMS), especially for microsensors and microactuators. In these devices, the mechanical properties, especially the stress in the polysilicon film, are critical to successful device fabrication. Polycrystalline Silicon for Integrated Circuits and Displays, Second Edition is an invaluable reference for professionals and technicians working with polycrystalline silicon in the integrated circuit and display industries. The fourth edition of CMOS Digital Integrated Circuits: Analysis and Design continues the well-established tradition of the earlier editions by offering the most comprehensive coverage of digital CMOS circuit design, as well as addressing state-of-the-art technology issues highlighted by the widespread use of nanometer-scale CMOS technologies. In this latest edition, virtually all chapters have been re-written, the transistor model equations and device parameters have been revised to reflect the significant changes that must be taken into account for new technology generations, and the material has been reinforced with up-to-date examples. The broad-ranging coverage of this textbook starts with the fundamentals of CMOS process technology, and continues with MOS transistor models, basic CMOS gates, interconnect effects, dynamic circuits, memory circuits, arithmetic building blocks, clock and I/O circuits, low power design techniques, design for manufacturability and design for testability.

Exponential improvement in functionality and performance of digital integrated circuits has revolutionized the way we live and work. The continued scaling down of MOS transistors has broadened the scope of use for circuit technology to the point that texts on the topic are generally lacking after a few years. The second edition of Digital Integrated Circuits: Analysis and Design focuses on timeless principles with a modern interdisciplinary view that will serve integrated circuits engineers from all disciplines for years to come. Providing a revised instructional reference for engineers involved with Very Large Scale Integrated Circuit design and fabrication, this book delves into the dramatic advances in the field, including new applications and changes in the physics of operation made possible by relentless miniaturization. This book was conceived in the versatile spirit of the

field to bridge a void that had existed between books on transistor electronics and those covering VLSI design and fabrication as a separate topic. Like the first edition, this volume is a crucial link for integrated circuit engineers and those studying the field, supplying the cross-disciplinary connections they require for guidance in more advanced work. For pedagogical reasons, the author uses SPICE level 1 computer simulation models but introduces BSIM models that are indispensable for VLSI design. This enables users to develop a strong and intuitive sense of device and circuit design by drawing direct connections between the hand analysis and the SPICE models. With four new chapters, more than 200 new illustrations, numerous worked examples, case studies, and support provided on a dynamic website, this text significantly expands concepts presented in the first edition.

With vastly increased complexity and functionality in the "nanometer era" (i.e. hundreds of millions of transistors on one chip), increasing the performance of integrated circuits has become a challenging task. Connecting effectively (interconnect design) all of these chip elements has become the greatest determining factor in overall performance. 3-D integrated circuit design may offer the best solutions in the near future. This is the first book on 3-D integrated circuit design, covering all of the technological and design aspects of this emerging design paradigm, while proposing effective solutions to specific challenging problems concerning the design of 3-D integrated circuits. A handy, comprehensive reference or a practical design guide, this book provides a sound foundation for the design of 3-D integrated circuits. * Demonstrates how to overcome "interconnect bottleneck" with 3-D integrated circuit design...leading edge design techniques offer solutions to problems (performance/power consumption/price) faced by all circuit designers * The FIRST book on 3-D integrated circuit design...provides up-to-date information that is otherwise difficult to find * Focuses on design issues key to the product development cycle...good design plays a major role in exploiting the implementation flexibilities offered in the 3-D * Provides broad coverage of 3-D integrated circuit design, including interconnect prediction models, thermal management techniques, and timing optimization...offers practical view of designing 3-D circuits

Top-down approach to practical, tool-independent, digital circuit design, reflecting how circuits are designed.

Beginning with discussions on the operation of electronic devices and analysis of the nucleus of digital design, the text addresses: the impact of interconnect, design for low power, issues in timing and clocking, design methodologies, and the effect of design automation on the digital design perspective.

Examines all important aspects of integrated circuit design, fabrication, assembly and test processes as they relate to quality and reliability. This second edition discusses in detail: the latest circuit design technology trends; the sources of error in wafer fabrication and assembly; avenues of contamination; new IC packaging methods; new in-line process monitors and test structures; and more.; This work should be useful to electrical and electronics, quality and reliability, and industrial engineers; computer scientists; integrated circuit manufacturers; and upper-level undergraduate, graduate and continuing-education students in these disciplines. When it comes to electronics, demand grows as technology shrinks. From consumer and industrial markets to military and aerospace applications, the call is for more functionality in smaller and smaller devices. Culled from the second edition of the best-selling Electronics Handbook, Microelectronics, Second Edition presents a summary of the current state of microelectronics and its innovative directions. This book focuses on the materials, devices, and applications of microelectronics technology. It details the IC design process and VLSI circuits,

including gate arrays, programmable logic devices and arrays, parasitic capacitance, and transmission line delays. Coverage ranges from thermal properties and semiconductor materials to MOSFETs, digital logic families, memory devices, microprocessors, digital-to-analog and analog-to-digital converters, digital filters, and multichip module technology. Expert contributors discuss applications in machine vision, ad hoc networks, printing technologies, and data and optical storage systems. The book also includes defining terms, references, and suggestions for further reading. This edition features two new sections on fundamental properties and semiconductor devices. With updated material and references in every chapter, *Microelectronics, Second Edition* is an essential reference for work with microelectronics, electronics, circuits, systems, semiconductors, logic design, and microprocessors. Intended for use in undergraduate senior-level digital circuit design courses with advanced material sufficient for graduate-level courses. Progressive in content and form, this text successfully bridges the gap between the circuit perspective and system perspective of digital integrated circuit design. Beginning with solid discussions on the operation of electronic devices and in-depth analysis of the nucleus of digital design, the text maintains a consistent, logical flow of subject matter throughout. The revision addresses today's most significant and compelling industry topics, including: the impact of interconnect, design for low power, issues in timing and clocking, design methodologies, and the tremendous effect of design automation on the digital design perspective. The revision reflects the ongoing evolution in digital integrated circuit design, especially with respect to the impact of moving into the deep-submicron realm.

For sophomore courses on digital design in an Electrical Engineering, Computer Engineering, or Computer Science department. & *Digital Design*, fourth edition is a modern update of the classic authoritative text on digital design. & This book teaches the basic concepts of digital design in a clear, accessible manner. The book presents the basic tools for the design of digital circuits and provides procedures suitable for a variety of digital applications. This book, first published in 2004, is an expanded and revised edition of Tom Lee's acclaimed RFIC text.

Praise for *CMOS: Circuit Design, Layout, and Simulation* Revised Second Edition from the Technical Reviewers "A refreshing industrial flavor. Design concepts are presented as they are needed for 'just-in-time' learning. Simulating and designing circuits using SPICE is emphasized with literally hundreds of examples. Very few textbooks contain as much detail as this one. Highly recommended!" --Paul M. Furth, New Mexico State University "This book builds a solid knowledge of CMOS circuit design from the ground up. With coverage of process integration, layout, analog and digital models, noise mechanisms, memory circuits, references, amplifiers, PLLs/DLLs, dynamic circuits, and data converters, the text is an excellent reference for both experienced and novice designers alike." --Tyler J. Gomm, Design Engineer, Micron Technology, Inc. "The Second Edition builds upon the success of the first with new chapters that cover additional material such as oversampled converters and non-volatile memories. This is becoming the de facto standard textbook to have on every analog and mixed-signal designer's bookshelf." --Joe Walsh, Design Engineer, AMI Semiconductor CMOS circuits from design to implementation *CMOS: Circuit Design, Layout, and Simulation, Revised Second Edition* covers the practical design of both analog and digital integrated circuits, offering a vital, contemporary view of a wide range of analog/digital circuit blocks, the BSIM model, data converter architectures, and much more. This edition takes a two-path approach to the topics: design techniques are developed for both long- and short-channel CMOS technologies and then compared. The results are multidimensional explanations that allow readers to gain deep insight into the design process. Features include: Updated materials to reflect CMOS technology's movement into nanometer sizes Discussions on phase- and delay-locked loops, mixed-signal circuits, data converters, and circuit noise More than 1,000 figures, 200

examples, and over 500 end-of-chapter problems In-depth coverage of both analog and digital circuit-level design techniques Real-world process parameters and design rules The book's Web site, CMOSedu.com, provides: solutions to the book's problems; additional homework problems without solutions; SPICE simulation examples using HSPICE, LTspice, and WinSpice; layout tools and examples for actually fabricating a chip; and videos to aid learning

- * Examines the various methods available for circuit protection, including coverage of the newly developed ESD circuit protection schemes for VLSI circuits.
- * Provides guidance on the implementation of circuit protection measures.
- * Includes new sections on ESD design rules, layout approaches, package effects, and circuit concepts.
- * Reviews the new Charged Device Model (CDM) test method and evaluates design requirements necessary for circuit protection.

Many interesting design trends are shown by the six papers on operational amplifiers (Op Amps). Firstly, there is the line of stand-alone Op Amps using a bipolar IC technology which combines high-frequency and high voltage. This line is represented in papers by Bill Gross and Derek Bowers. Bill Gross shows an improved high-frequency compensation technique of a high quality three stage Op Amp. Derek Bowers improves the gain and frequency behaviour of the stages of a two-stage Op Amp. Both papers also present trends in current-mode feedback Op Amps. Low-voltage bipolar Op Amp design is presented by Ieroen Fonderie. He shows how multipath nested Miller compensation can be applied to turn rail-to-rail input and output stages into high quality low-voltage Op Amps. Two papers on CMOS Op Amps by Michael Steyaert and Klaas Bult show how high speed and high gain VLSI building blocks can be realised. Without departing from a single-stage OT A structure with a folded cascode output, a thorough high frequency design technique and a gain-boosting technique contributed to the high-speed and the high-gain achieved with these Op Amps. . Finally, Rinaldo Castello shows us how to provide output power with CMOS buffer amplifiers. The combination of class A and AB stages in a multipath nested Miller structure provides the required linearity and bandwidth. Presenting a comprehensive overview of the design automation algorithms, tools, and methodologies used to design integrated circuits, the Electronic Design Automation for Integrated Circuits Handbook is available in two volumes. The second volume, EDA for IC Implementation, Circuit Design, and Process Technology, thoroughly examines real-time logic to GDSII (a file format used to transfer data of semiconductor physical layout), analog/mixed signal design, physical verification, and technology CAD (TCAD). Chapters contributed by leading experts authoritatively discuss design for manufacturability at the nanoscale, power supply network design and analysis, design modeling, and much more. Save on the complete set.

This book contains all the topics of importance to the low power designer. It first lays the foundation and then goes on to detail the design process. The book also discusses such special topics as power management and modal design, ultra low power, and low power design methodology and flows. In addition, coverage includes projections of the future and case studies.

An introduction to basic circuit design, employing a variety of semiconductor devices, integrated structures, analog circuits, and low-power switching circuits. Describes the electrical characteristics and applications of semiconductor devices, covering amplifier stages, biasing, difference stages, noise, integrated circuits, frequency-dependent circuits, discrete and field-effect devices, switching devices, semiconductor transducers, and power supplies. Analogue-to-digital and digital-to-analogue converters are also considered. Closing chapters introduce the concept of computer-aided design and describe how application-specific integrated circuits may be designed and produced. Includes end-of-chapter questions and numerical problems.

Digital Integrated Circuits A Design Perspective

KEY BENEFIT: This hands-on book leads readers through the complete process of building a ready-to-fabricate CMOS integrated circuit using popular commercial design

software. KEY TOPICS: The VLSI CAD flow described in this book uses tools from two vendors: Cadence Design Systems, Inc. and Synopsys Inc. Detailed tutorials include step-by-step instructions and screen shots of tool windows and dialog boxes. MARKET: A useful reference for chip designers.

The 2nd Edition of Analog Integrated Circuit Design focuses on more coverage about several types of circuits that have increased in importance in the past decade. Furthermore, the text is enhanced with material on CMOS IC device modeling, updated processing layout and expanded coverage to reflect technical innovations. CMOS devices and circuits have more influence in this edition as well as a reduced amount of text on BiCMOS and bipolar information. New chapters include topics on frequency response of analog ICs and basic theory of feedback amplifiers.

This is the only comprehensive book in the market for engineers that covers the design of CMOS and bipolar analog integrated circuits. The fifth edition retains its completeness and updates the coverage of bipolar and CMOS circuits. A thorough analysis of a new low-voltage bipolar operational amplifier has been added to Chapters 6, 7, 9, and 11. Chapter 12 has been updated to include a fully differential folded cascode operational amplifier example. With its streamlined and up-to-date coverage, more engineers will turn to this resource to explore key concepts in the field.

This newly revised and expanded edition of the 2003 Artech House classic, Radio Frequency Integrated Circuit Design, serves as an up-to-date, practical reference for complete RFIC know-how. The second edition includes numerous updates, including greater coverage of CMOS PA design, RFIC design with on-chip components, and more worked examples with simulation results. By emphasizing working designs, this book practically transports you into the authors' own RFIC lab so you can fully understand the function of each design detailed in this book. Among the RFIC designs examined are RF integrated LC-based filters, VCO automatic amplitude control loops, and fully integrated transformer-based circuits, as well as image reject mixers and power amplifiers. If you are new to RFIC design, you can benefit from the introduction to basic theory so you can quickly come up to speed on how RFICs perform and work together in a communications device. A thorough examination of RFIC technology guides you in knowing when RFICs are the right choice for designing a communication device. This leading-edge resource is packed with over 1,000 equations and more than 435 illustrations that support key topics."

Learn the basic properties and designs of modern VLSI devices, as well as the factors affecting performance, with this thoroughly updated second edition. The first edition has been widely adopted as a standard textbook in microelectronics in many major US universities and worldwide. The internationally renowned authors highlight the intricate interdependencies and subtle trade-offs between various practically important device parameters, and provide an in-depth discussion of device scaling and scaling limits of CMOS and bipolar devices. Equations and parameters provided are checked continuously against the reality of silicon data, making the book equally useful in practical transistor design and in the classroom. Every chapter has been updated to include the latest developments, such as MOSFET scale length theory, high-field transport model and SiGe-base bipolar devices.

Market_Desc: Engineers Special Features: " Updates the coverage of bipolar technologies" Enhances the discussion of biCMOS" Provides a more unified treatment

of digital and analog circuit design while strengthening the coverage of CMOS" Removes the chapter on non-linear analog circuits" Adds a new operational amplifier example to chapter 11 About The Book: This is the only comprehensive book in the market for engineers that covers CMOS, bipolar technologies, and biCMOS integrated circuits. The fifth edition retains its completeness, updates the coverage of bipolar technologies, and enhances the discussion of biCMOS. It provides a more unified treatment of digital and analog circuit design while strengthening the coverage of CMOS. The chapter on non-linear analog circuits has been removed and chapter 11 has been updated to include an operational amplifier example. With its streamlined and up-to-date coverage, more engineers can turn to this resource to explore key concepts in the field.

A transistor-level, design-intensive overview of high speed and high frequency monolithic integrated circuits for wireless and broadband systems from 2 GHz to 200 GHz, this comprehensive text covers high-speed, RF, mm-wave, and optical fibre circuits using nanoscale CMOS, SiGe BiCMOS, and III-V technologies. Step-by-step design methodologies, end-of chapter problems, and practical simulation and design projects are provided, making this an ideal resource for senior undergraduate and graduate courses in circuit design. With an emphasis on device-circuit topology interaction and optimization, it gives circuit designers and students alike an in-depth understanding of device structures and process limitations affecting circuit performance.

As electronic devices become increasingly prevalent in everyday life, digital circuits are becoming even more complex and smaller in size. This book presents the basic principles of digital electronics in an accessible manner, allowing the reader to grasp the principles of combinational and sequential logic and the underlying techniques for the analysis and design of digital circuits. Providing a hands-on approach, this work introduces techniques and methods for establishing logic equations and designing and analyzing digital circuits. Each chapter is supplemented with practical examples and well-designed exercises with worked solutions. This second of three volumes focuses on sequential and arithmetic logic circuits. It covers various aspects related to the following topics: latch and flip-flop; binary counters; shift registers; arithmetic and logic circuits; digital integrated circuit technology; semiconductor memory; programmable logic circuits. Along with the two accompanying volumes, this book is an indispensable tool for students at a bachelors or masters level seeking to improve their understanding of digital electronics, and is detailed enough to serve as a reference for electronic, automation and computer engineers.

Unlike books currently on the market, this book attempts to satisfy two goals: combine circuits and electronics into a single, unified treatment, and establish a strong connection with the contemporary world of digital systems. It will introduce a new way of looking not only at the treatment of circuits, but also at the treatment of introductory coursework in engineering in general. Using the concept of "abstraction," the book attempts to form a bridge between the world of physics and the world of large computer systems. In particular, it attempts to unify electrical engineering and computer science as the art of creating and exploiting successive abstractions to manage the complexity of building useful electrical systems. Computer systems are simply one type of electrical systems. +Balances circuits theory with practical digital electronics

applications. +Illustrates concepts with real devices. +Supports the popular circuits and electronics course on the MIT OpenCourse Ware from which professionals worldwide study this new approach. +Written by two educators well known for their innovative teaching and research and their collaboration with industry. +Focuses on contemporary MOS technology.

Presents an introduction to the open-source electronics prototyping platform.

Contains the most extensive coverage of digital integrated circuits available in a single source. Provides complete qualitative descriptions of circuit operation followed by in-depth analytical analyses and spice simulations. The circuit families described in detail are transistor-transistor logic (TTL, STTL, and ASTTL), emitter-coupled logic (ECL), NMOS logic, CMOS logic, dynamic CMOS, BiCMOS structures and various GASFET technologies. In addition to detailed presentation of the basic inverter circuits for each digital logic family, complete details of other logic circuits for these families are presented.

Intuitive Analog Circuit Design outlines ways of thinking about analog circuits and systems that let you develop a feel for what a good, working analog circuit design should be. This book reflects author Marc Thompson's 30 years of experience designing analog and power electronics circuits and teaching graduate-level analog circuit design, and is the ideal reference for anyone who needs a straightforward introduction to the subject. In this book, Dr. Thompson describes intuitive and "back-of-the-envelope" techniques for designing and analyzing analog circuits, including transistor amplifiers (CMOS, JFET, and bipolar), transistor switching, noise in analog circuits, thermal circuit design, magnetic circuit design, and control systems. The application of some simple rules of thumb and design techniques is the first step in developing an intuitive understanding of the behavior of complex electrical systems. Introducing analog circuit design with a minimum of mathematics, this book uses numerous real-world examples to help you make the transition to analog design. The second edition is an ideal introductory text for anyone new to the area of analog circuit design. Design examples are used throughout the text, along with end-of-chapter examples Covers real-world parasitic elements in circuit design and their effects Diode Lasers and Photonic Integrated Circuits, Second Edition provides a comprehensive treatment of optical communication technology, its principles and theory, treating students as well as experienced engineers to an in-depth exploration of this field. Diode lasers are still of significant importance in the areas of optical communication, storage, and sensing. Using the the same well received theoretical foundations of the first edition, the Second Edition now introduces timely updates in the technology and in focus of the book. After 15 years of development in the field, this book will offer brand new and updated material on GaN-based and quantum-dot lasers, photonic IC technology, detectors, modulators and SOAs, DVDs and storage, eye diagrams and BER concepts, and DFB lasers. Appendices will also be expanded to include quantum-dot issues and more on the relation between spontaneous emission and gain.

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